

## METHOD FOR MIN-CUT AND RATIO MIN-CUT PARTITIONING

### Abstract of the Disclosure

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The method of Edge-Node Interleave Sort for Leaching and Envelop (ENISLE) comprises mapping a circuit into a  $V$ - $E$  plain to transform a circuit information into  $V$ - $E$  plain. A plurality of sorting is performed for obtaining min-cut or/and ratio min-cut partitioning. The sorting includes (1) performing  
10 a first sorting step from an edge view based on a bottom side of the  $V$ - $E$  plain; (2) performing a second sorting step from an node view based on a right side of the  $V$ - $E$  plain; (3) performing a third sorting from said edge view based on a top side of the  $V$ - $E$  plain; and (4) performing a fourth sorting step from said node view based on a left side of the  $V$ - $E$  plain.

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